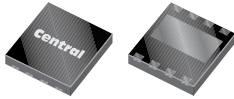


CDFG6511N

**SURFACE MOUNT GaN
N-CHANNEL
POWER FET
11 AMP, 650 VOLT**



Top View Bottom View

DFN8X8 CASE



www.centrasemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CDFG6511N is a 650 Volt N-Channel GaN FET designed for high voltage, soft switching applications. This GaN FET combines high voltage capability with low $r_{DS(ON)}$ and low gate charge for optimal efficiency.

MARKING: C6511 L/C D/C

APPLICATIONS:

- Switch-mode power supplies
- High power chargers
- Electric vehicle inverters

FEATURES:

- High voltage capability
- Low gate charge & $r_{DS(ON)}$
- Fast switching

MAXIMUM RATINGS: ($T_J=25^\circ\text{C}$ unless otherwise noted)

	SYMBOL		UNITS
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	-1.4 to +7.0	V
Continuous Drain Current ($T_C=25^\circ\text{C}$)	I_D	11.5	A
Pulsed Drain Current ($T_C=25^\circ\text{C}$)	I_{DM}	20.5	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	84	W
Power Dissipation ($T_A=25^\circ\text{C}$)	P_D	1.1	W
Operating and Storage Junction Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS: ($T_J=25^\circ\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{GSSF}	$V_{GS}=6.0\text{V}, V_{DS}=0$		60		μA
I_{GSSR}	$V_{GS}=1.0\text{V}, V_{DS}=0$		60		μA
I_{DSS}	$V_{DS}=650\text{V}, V_{GS}=0$		0.45	20	μA
BV_{DSS}	$V_{GS}=0, I_D=250\mu\text{A}$	650			V
$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=12.2\text{mA}$	1.2	1.7	2.5	V
V_{SD}	$V_{GS}=0, I_S=3.9\text{A}$		2.6		V
$r_{DS(ON)}$	$V_{GS}=6.0\text{V}, I_D=3.9\text{A}$		138	190	$\text{m}\Omega$
C_{iss}	$V_{DS}=400\text{V}, V_{GS}=0, f=100\text{kHz}$		96		pF
C_{oss}	$V_{DS}=400\text{V}, V_{GS}=0, f=100\text{kHz}$		30		pF
C_{rss}	$V_{DS}=400\text{V}, V_{GS}=0, f=100\text{kHz}$		0.5		pF
$C_{oss(er)}$	$V_{DS}=0$ to 400V, $V_{GS}=0$		43		pF
$C_{oss(tr)}$	$V_{DS}=0$ to 400V, $V_{GS}=0$		60		pF
$Q_g(\text{tot})$	$V_{DS}=400\text{V}, V_{GS}=0$ to 6.0V, $I_D=3.9\text{A}$		2.8		nC
Q_{gd}	$V_{DS}=400\text{V}, V_{GS}=0$ to 6.0V, $I_D=3.9\text{A}$		1.1		nC
Q_{gs}	$V_{DS}=400\text{V}, V_{GS}=0$ to 6.0V, $I_D=3.9\text{A}$		0.25		nC

R3 (17-July 2024)

CDFG6511N

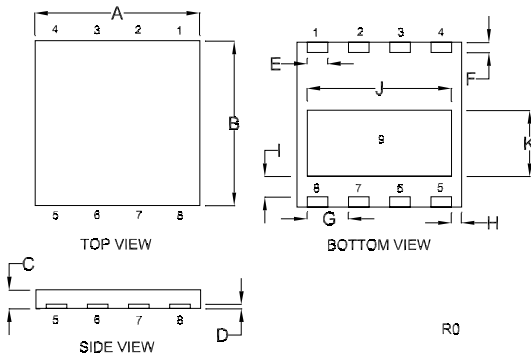
**SURFACE MOUNT GaN
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POWER FET
11 AMP, 650 VOLT**



ELECTRICAL CHARACTERISTICS - Continued: ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	TYP	UNITS
$t_{d(on)}$	$V_{DS}=400\text{V}$, $V_{GS}=6.0\text{V}$, $I_D=8.0\text{A}$ $R_{G(on)}=10\Omega$, $L=318\mu\text{H}$	1.4	ns
$t_{d(off)}$	$V_{DS}=400\text{V}$, $V_{GS}=6.0\text{V}$, $I_D=8.0\text{A}$ $R_{G(on)}=10\Omega$, $L=318\mu\text{H}$	1.7	ns
t_r	$V_{DS}=400\text{V}$, $V_{GS}=6.0\text{V}$, $I_D=8.0\text{A}$ $R_{G(on)}=10\Omega$, $L=318\mu\text{H}$	4.0	ns
t_f	$V_{DS}=400\text{V}$, $V_{GS}=6.0\text{V}$, $I_D=8.0\text{A}$ $R_{G(on)}=10\Omega$, $L=318\mu\text{H}$	4.0	ns

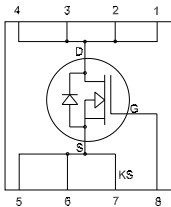
DFN8X8 CASE - MECHANICAL OUTLINE



SYMBOL	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.307	0.323	7.80	8.20
B	0.307	0.323	7.80	8.20
C	0.031	0.039	0.80	1.00
D	0.006	0.010	0.15	0.25
E	0.037	0.041	0.95	1.05
F	0.018	0.022	0.45	0.55
G	0.071	0.087	1.80	2.20
H	0.018	0.022	0.45	0.55
I	0.037	0.041	0.95	1.05
J	0.268	0.283	6.80	7.20
K	0.120	0.132	3.05	3.35

DFN8X8 (REV: R0)

PIN CONFIGURATION



LEAD CODE:

- 1) Drain 5) Source
- 2) Drain 6) Source
- 3) Drain 7) Kelvin Source
- 4) Drain 8) Gate

Pins 5, 6, 7 are common to the pad (9)

MARKING: C6511 L/C D/C

R3 (17-July 2024)

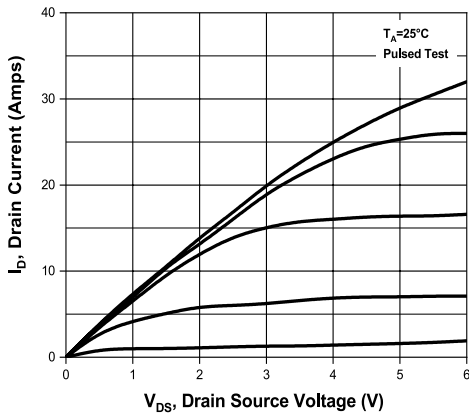
CDFG6511N

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11 AMP, 650 VOLT

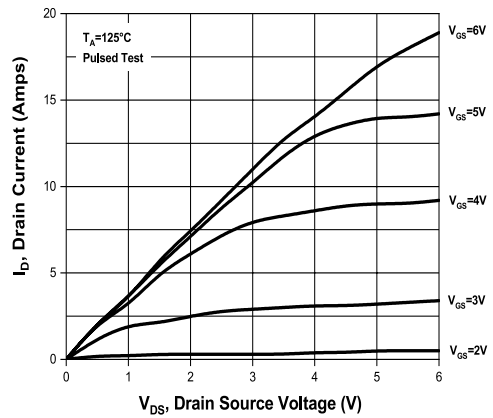


TYPICAL ELECTRICAL CHARACTERISTICS

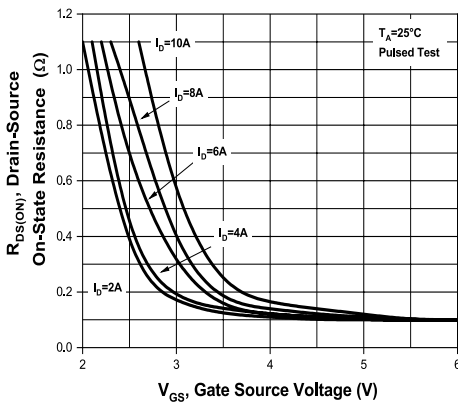
Typical Output Characteristics



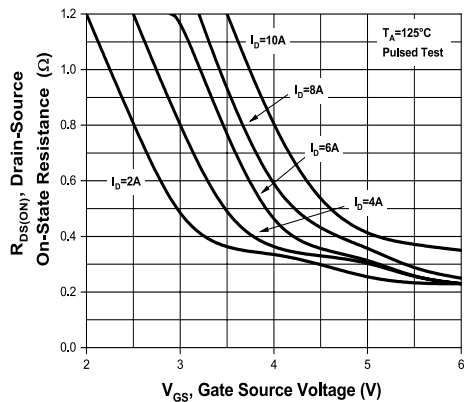
Typical Output Characteristics



Drain Source On Resistance



Drain Source On Resistance



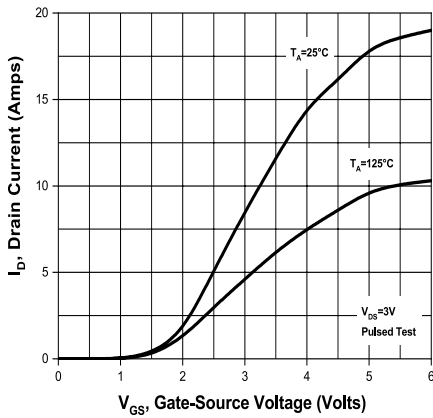
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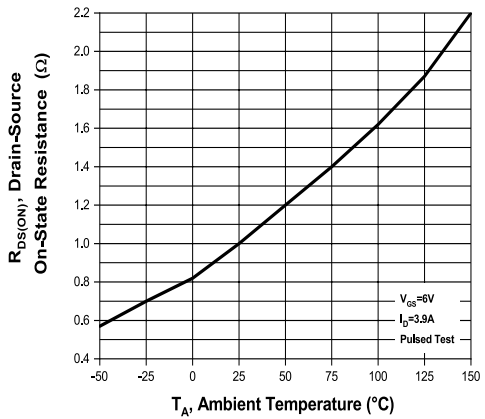


TYPICAL ELECTRICAL CHARACTERISTICS

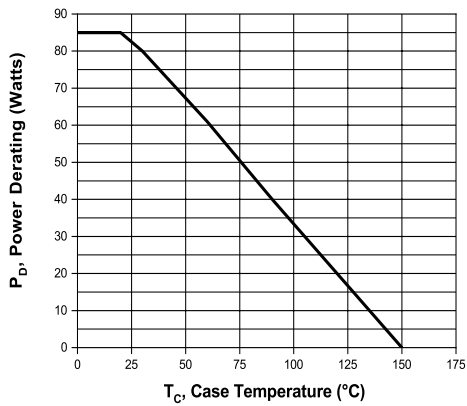
Transfer Characteristics



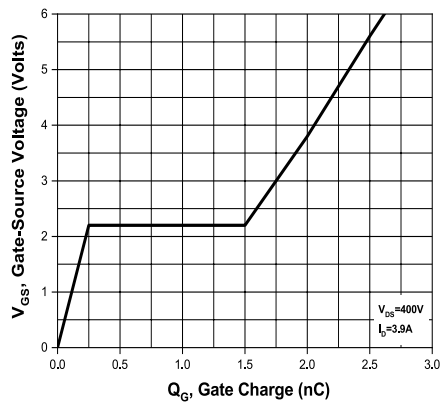
Drain Source Temperature Coefficient



Power Derating



Gate Capacitance Charge

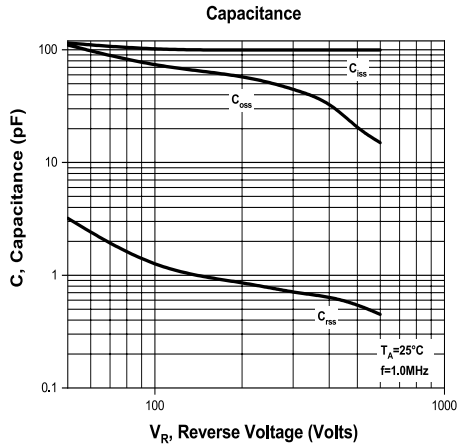


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TYPICAL ELECTRICAL CHARACTERISTICS



OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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